

GLASS PASSIVATED CHIP SINGLE-PHASE BRIDGE RECTIFIER

Reverse Voltage - 50 to 1000 Volts Forward Current 6.0 Amperes

Features

- Thin Single In-Line package
- Ideal for printed circuit boards
- Glass passivated chip junction
- High surge current capability
- ♦ High case dielectric strength of 2500 V_{RMS}
- Plastic package has Underwriters Laboratory Flammability Classification 94V-0

Mechanical Data

- Case: GBJ(5S) Epoxy meets UL-94V-0 Flammability rating
- Terminals: Plated leads solderable per MIL-STD-750, Method 2026
- ♦ High temperature soldering guaranteed: 260°C/10 seconds, 0.375 (9.5mm) lead length, 5lbs.(2.3kg) tension
- Polarity: As marked on body
- ◆ Mounting Torque: 10 cm-kg (8.8 inches-lbs) max.
- Recommended Torque: 5.7cm-kg (5 inches-lbs)

Boting at 2E°C ambient temporature uplace atherwise aposition

Typical Applications

General purpose use in ac-to-dc bridge full wave rectification for Switching Power Supply, Home Appliances, Office Equipment, Industrial Automation applications





Package outline dimensions in millimeters

Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.									
Parameter	Symbols	GBJ6A	GBJ6B	GBJ6D	GBJ6G	GBJ6J	GBJ6K	GBJ6M	Units
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum average forward $T_c=100^{\circ}C$ rectified output current at $T_A=25^{\circ}C$	I _{F(AV)}	6.0 ⁽¹⁾ 2.8 ⁽²⁾							Amps
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{fsm}	150.0							Amps
Rating for fusing (t<8.3ms)	۴t	93							A ² sec
Maximum instantaneous forward voltage drop per leg at 3.0A	V _F	1.0							Volt
Maximum DC reverse current $T_{A}=25^{\circ}C$ at rated DC blocking voltage per leg $T_{A}=125^{\circ}C$	I _R	5 250							uA
Typical thermal resistance per leg	R _{eJA} R _{eJC}	22 ⁽²⁾ 3.4 ⁽¹⁾							∘C/W
Dielectric strength (Therm nals to case, AC 1 m nute)	V _{ISO}	2500							Volts
Operating junction and storage temperature range	T _J , T _{stg}	-55 to +150							°C

Notes 1. Unit case mounted on 9.5x9.5x0.15cm thick AI plate heatsink

2. Units mounted on P.C.B. with 0 5 x 0.5" (13 x 13 mm) copper pads and 0.375" (9.5 mm) lead length

3. Recommended mounting position is to bolt down on heatsink with silicone thermal compound for maximum heat transfer with #6 screw





RATINGS AND CHARACTERISTIC CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$



Figure 1. Derating Curve Output Rectified Current



Figure 2. Maximum Non-Repetitive Peak Forward Surge Current Per Leg



Figure 5. Typical Junction Capacitance Per Leg



Figure 3. Typical Forward Characteristics Per Leg



Figure 4. Typical Reverse Characteristics Per Leg



Figure 6. Typical Transient Thermal Impedance

First Silicon